Surface Mount General Purpose Silicon Rectifiers

Reverse Voltage - 50 to 1000 V

Forward Current - 2 A

FEATURES

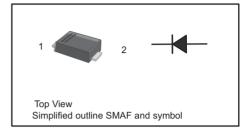
- For surface mounted applications
- · Low profile package
- Glass Passivated Chip Junction
- · Easy to pick and place
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- · Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Maximum Ratings and Electrical characteristics

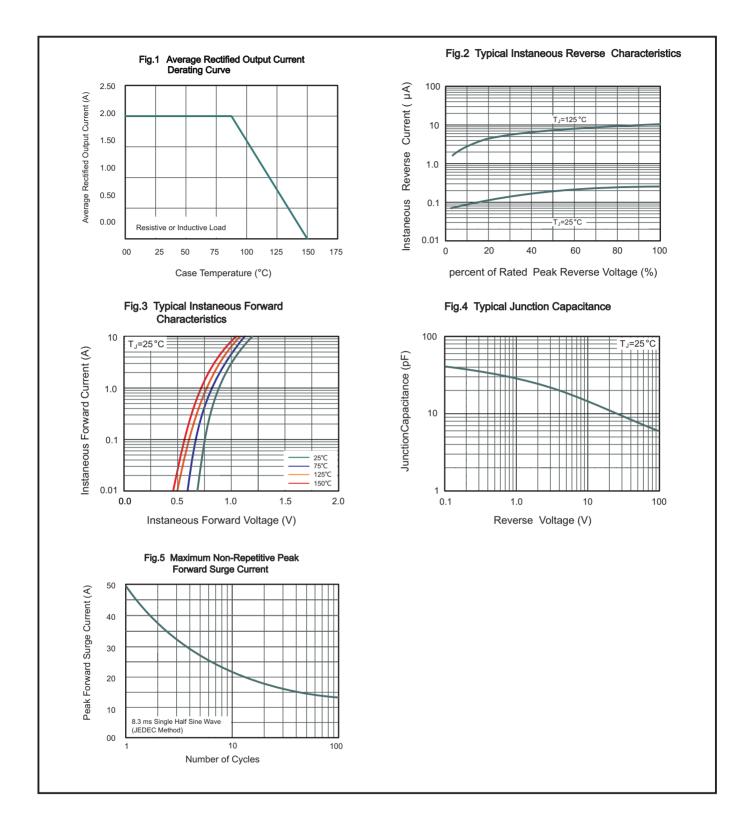
Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	S2AF	S2BF	S2DF	S2GF	S2JF	S2KF	S2MF	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current@ Fig.1	I _{F(AV)}	2							А
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	50							А
Peak Forward Surge Current,1ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	100						А	
I²t Rating for fusing(3ms≤t≤8.3ms)	l ² t	10.4							A ² S
Maximum Instantaneous Forward Voltage at 2 A	V _F	1.1						V	
Maximum DC Reverse Current $T_j = 25 ^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_j = 125 ^{\circ}\text{C}$	I _R	5 100						μA	
Typical Junction Capacitance (1)	C _j	20						pF	
Typical Thermal Resistance (2)	R _{eja} R _{ejc} R _{ejl}	100 20 30						°C/W	
Operating and Storage Temperature Range	T_{j}, T_{stg}			-	·55 ~ +15	0			°C

^(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

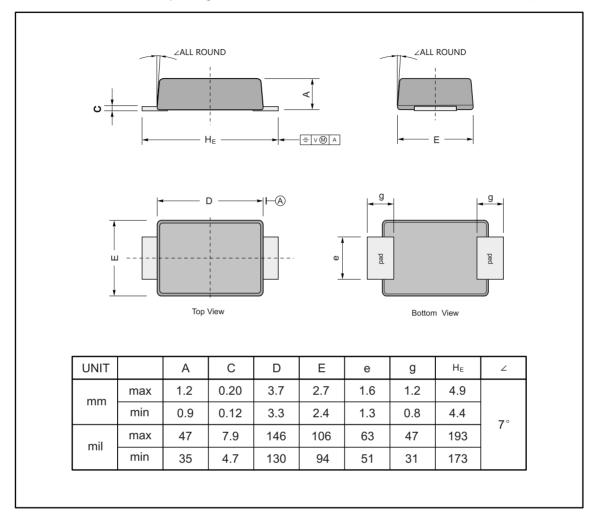
^(2) P.C.B. mounted with 0.2"X 0.2" (5 X 5 mm) copper pad areas.



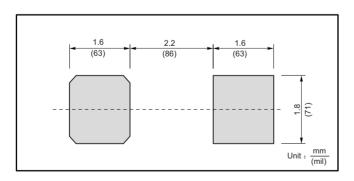
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF



The recommended mounting pad size



Marking

Type number	Marking code				
S2AF	S2A				
S2BF	S2B				
S2DF	S2D				
S2GF	S2G				
S2JF	S2J				
S2KF	S2K				
S2MF	S2M				

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